Theoretical modeling of XBn T2SLs InAs/InAsSb/B-AlAsSb mid-wave detector operating below thermoelectrical cooling

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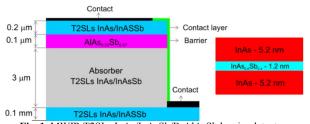
Abstract–The paper reports on the barrier mid-wave infrared InAs/InAsSb ($x_{Sb} = 0.4$) type-II superlattice operating below thermoelectrical cooling. AlAsSb ($x_{Sb} = 0.97$) barrier was proved to be proper material not introducing extra barrier in valence band in analyzed temperature range. The highest detectivity of the simulated structure was assessed at the level of ~ 10^{12} Jones at $T \sim 100$ K.

I. INTRODUCTION

Infrared detectors have many applications in civilian and military environment. Currently, many of these infrared applications requires high-performance Mercury Cadmium Telluride (MCT) photodetectors. Due to higher cost of the MCT, antimonide based type-II superlattices (T2SLs) have been proposed as an alternative with lower fabrication cost and better performance with low dark current due to suppressed Auger generation-recombination (GR) rate and tunneling current [1,2]. It must be underlined that those theoretical predictions has not been reached yet. The limiting factor of the widely studied T2SLs InAs/GaSb is the short minority carrier lifetime. That could be circumvented by "Gafree" T2SLs InAs/InAsSb revealing very encouraging results in terms of carrier lifetime ~ 400 ns due to strong suppression of nonradiative recombination [3–5]. Expect material, it has been demonstrated that the XBn structure suppresses the dark current in infrared photodetectors effectively through bandgap engineering [6]. In this paper, we demonstrate theoretical modeling of MWIR XBn photodetectors with T2SLs InAs/InAsSb active layer where AlAsSb barrier was incorporated. It is shown that AlAsSb ($x_{Sb} = 0.97$) does not introduce extra barriers in valence band of the XBn structure.

II. SIMULATION PROCEDURE AND RESULTS

The nominal simulated T2SLs InAs/InAsSb/B-AlAsSb barrier structure is presented in Fig. 1.





The T2SLs InAs/InAsSb contact layers (0.2 μ m n/p-type, 10¹⁶ cm⁻³ and 0.1 μ m n-type 5×10¹⁷ cm⁻³) and absorber (3 μ m,

 5×10^{15} cm⁻³) were assumed to have 5.2 nm (InAs) and 1.2 nm (InAsSb) while Sb composition $x_{Sb} = 0.4$. The 0.1 nm, n-type 10^{16} cm⁻³ AlAsSb ($x_{Sb} = 0.97$) barrier was introduced to the detector's structure.

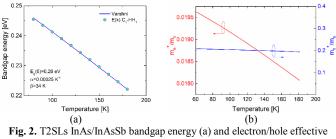
Table 1. Material parameters taken in modeling of T2SLs InAs/InAsSb.

| Parameters | Symbols | GaAs | InAs | InSb | GaSb |
|---|------------------------------|-----------|-----------------------|-----------|-----------|
| Lattice constant | $a_T(\text{\AA}/K)$ | 3.88×10-5 | 2.74×10 ⁻⁵ | 3.48×10-5 | 4.72×10-5 |
| $a(T)=a(T=300K)+a_T \times (T-300)$ | a(T=300K)(Å) | 5.65325 | 6.0583 | 6.4794 | 6.0959 |
| Bandgap | α (meV/K) | 0.5405 | 0.276 | 0.32 | 0.417 |
| $E_a^{\Gamma}(T) =$ | $\beta(K)$ | 204 | 93 | 170 | 140 |
| $E_g^{\Gamma}(T=0K) - \frac{\alpha T^2}{T+\beta}$ | $E_g^{\Gamma}(T=0K)$ (eV) | 1.519 | 0.417 | 0.25 | 0.812 |
| | γ ₁ | 7.05 | 20.0 | 34.8 | 13.4 |
| Luttinger parameters | γ_2 | 2.35 | 8.5 | 15.5 | 4.7 |
| | γ ₃ | 3 | 9.2 | 16.5 | 6 |
| Deformation potentials | $a_c(eV)$ | -7.17 | -5.08 | -6.94 | -7.5 |
| | $a_v(eV)$ | -1.16 | -1 | -0.36 | -0.8 |
| | b(eV) | -2 | -1.8 | -2 | -2 |
| | d(eV) | -4.8 | -3.6 | -4.7 | -4.7 |
| Elastic constant | $C_{11}(\text{GPa})$ | 1221 | 832.9 | 684.7 | 884.2 |
| | $C_{12}(\text{GPa})$ | 566 | 452.6 | 373.5 | 402.6 |
| | $C_{44}(\text{GPa})$ | 600 | 395.9 | 311.1 | 432.2 |
| Spin-orbit energy | $\Delta_0(eV)$ | 0.341 | 0.39 | 0.82 | 0.76 |
| Kane potential | $E_p(eV)$ | 23.81 | 21.5 | 24.08 | 24.76 |
| Electron affinity | (eV) | 4.07 | 4.9 | 4.59 | 4.06 |
| Valence band offset | VBO(eV) | -0.8 | -0.59 | 0 | -0.03 |
| Effective mass (0K) | $\frac{m_e^*}{m_0}$ | 0.064 | 0.023 | 0.0138 | 0.038 |

Table 2. Bowing parameters for InAsSb.

| | $E_g^{\Gamma}(eV)$ | 0.67 |
|-------------------|--------------------|-------|
| Bowing parameters | $\Delta_0(eV)$ | 1.2 |
| | $m_e^*(\Gamma)$ | 0.035 |

The 8×8 kp method was used to calculate bandgap energy and effective masses in plane and growth direction for T2SLs InAs/InAsSb. The material parameters assumed in T2SLs InAs/InAsSb modeling are presented in Table 1 and 2 [7]. The T2SLs InAs/InAsSb bandgap energy versus temperature and fitted Varshni equation are presented in Fig. 2 (a) while electron and hole effective masses are presented in Fig. 2 (b). Detector structure was simulated with software APSYS by Crosslight Inc. using bulk based model.



masses (b) versus temperature.

Calculated energy band diagrams for nB_nnn^+ and pB_nnn^+ were presented in Fig. 3 (a) and (b) respectively for 80 K and

unbiased condition. For n-type contact layer extra barrier in valence band is visible while barrier in conduction band is close to 1.5 eV.

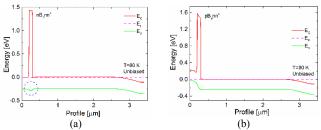


Fig. 3. Energy band diagram for MWIR T2SLs InAs/InAsSb/B-AlAsSb barrier structure for two detector's architectures: nB_nnn^+ (a) and pB_nnn^+ (b) for unbiased condition simulated for T = 80 K.

Dark current characteristics versus reciprocal temperature for two detector's architectures: nB_nnn^+ and pB_nnn^+ are presented in Fig. 4 (a) and (b).

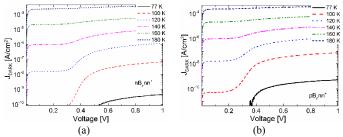


Fig. 4. Dark current for detector's architectures: nB_nnn^+ (a) and pB_nnn^+ (b) versus voltage for selected temperatures: 77–180 K.

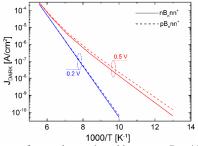


Fig. 5. Dark current for two detector's architectures: nB_nnn^+/pB_nnn^+ versus reciprocal temperature and selected voltages: 0.2 V and 0.5 V.

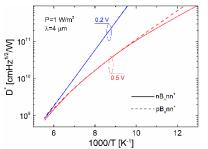


Fig. 6. Detectivity for two detector's architectures: nB_nnn^+/pB_nnn^+ versus reciprocal temperature and selected voltages: 0.2 V and 0.5 V.

Detectivity was calculated assuming thermal Johnson-Nyquist and shot noises according to the relation:

$$D^* = \frac{R_i}{\left(\frac{4k_BT}{RA} + 2qJ_{DARK}\right)^{0.5}} \tag{1}$$

where: R_i , k_B , R, A, stands for current responsivity, Boltzmann constant, resistance and detector's electrical area.

III. CONCLUSIONS

We demonstrated theoretical modeling of MWIR XBn photodetectors with T2SLs InAs/InAsSb active layer where AlAsSb barrier was implemented. It was shown that material does not introduce extra barriers in valence band in analyzed XBn structure. The highest detectivity of the simulated structure was assessed at the level of ~ 10^{12} Jones for $T \sim 100$ K.

ACKNOWLEDGMENT

This paper has been completed with the financial support of The National Centre for Research and Development-the grant no. PL-TW4/3/2017.

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